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S&H Form: (10/01)

**REPLY/AMENDMENT
FEE TRANSMITTAL**

Attorney Docket No.	21.1931
Application Number	09/339,199
Filing Date	June 24, 1999
First Named Inventor	Fumiaki NAKATAKE et.al.
Group Art Unit	2879

AMOUNT ENCLOSED

1160.00

Examiner Name

K. Ramsey

FEE CALCULATION (fees effective 10/01/00)

CLAIMS AS AMENDED	Claims Remaining After Amendment	Highest Number Previously Paid For	Number Extra	Rate	Calculations
TOTAL CLAIMS	30	26 =	4	X \$ 18.00 =	\$ 72.00
INDEPENDENT CLAIMS	7	5 =	2	X \$ 84.00 =	168.00
Since an Official Action set an <u>original</u> due date of <u>July 20, 2001</u> , petition is hereby made for an extension to cover the date this reply is filed for which the requisite fee is enclosed (1 month (\$110); 2 months (\$400); 3 months (\$920); 4 months (\$1,440); 5 months (\$1,960)):					920.00
If Notice of Appeal is enclosed, add (\$320)					0.00
If Statutory Disclaimer under Rule 20(d) is enclosed, add fee (\$110)					0.00
Total of above Calculations =					\$ 1160.00
Reduction by 50% for filing by small entity (37 CFR 1.9, 1.27 & 1.28)					
TOTAL FEES DUE =					\$ 1160.00

- (1) If entry (1) is less than entry (2), entry (3) is "0".
(2) If entry (2) is less than 20, change entry (2) to "20".
(4) If entry (4) is less than entry (5), entry (6) is "0".
(5) If entry (5) is less than 3, change entry (5) to "3".

CERTIFICATE UNDER 37 CFR 1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231

METHOD OF PAYMENT

- ☒ Check enclosed as payment.
- ☐ Charge "TOTAL FEES DUE" to the Deposit Account No. below.
- ☐ No payment is enclosed and no charges to the Deposit Account are authorized at this time (unless specifically required to obtain a filing date).

GENERAL AUTHORIZATION

- ☒ If the above-noted "AMOUNT ENCLOSED" is not correct, the Commissioner is hereby authorized to credit any overpayment or charge any additional fees necessary to:
- | | |
|----------------------|--------------------|
| Deposit Account No. | 19-3935 |
| Deposit Account Name | STAAS & HALSEY LLP |
- ☒ The Commissioner is also authorized to credit any overpayments or charge any additional fees required under 37 CFR 1.16 (filing fees) or 37 CFR 1.17 (processing fees) during the prosecution of this application, including any related application(s) claiming benefit hereof pursuant to 35 USC § 120 (e.g., continuations/divisionals/CIPs under 37 CFR 1.53(b) and/or continuations/divisionals/CPAs under 37 CFR 1.53(d)) to maintain pendency hereof or of any such related application.

SUBMITTED BY: STAAS & HALSEY LLP

Typed Name H. J. Staas

Reg. No. 22,010

Signature

Date October 22, 2001

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Docket No.: 21.1931

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Fumiaki NAKATAKE et al.

Serial No. 09/339,199

Group Art Unit: 2879

Confirmation No.

Filed: June 24, 1999

Examiner: K. Ramsey

For: MANUFACTURING METHOD OF PLASMA DISPLAY PANELS

AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

01/16/2002 SZEWDIE1 00000061 09339199

01 FC:117

920.00 OP

Sir:

This is in response to the Office Action mailed April 20, 2001, and having a period for response set to expire on July 20, 2001. A Petition for a three-month extension of time, together with the requisite fee for same, is submitted herewith, thereby extending the period for response to October 20/22, 2001.

The following amendments and remarks are respectfully submitted. Reconsideration of the claims is respectfully requested.

01/16/2002 SZEWDIE1 00000061 09339199

02 FC:102

168.00 OP

03 FC:103

72.00 OP

IN THE SPECIFICATION:

Please correct the specification in accordance with the attached AMENDED SPECIFICATION and with respect to which there further is attached a SUBSTITUTE SPECIFICATION, incorporating the amendments of the AMENDED SPECIFICATION.

IN THE CLAIMS:

Please REPLACE claims 1-26 and ADD new claims 27-30 in accordance with the following:

1. (AS ONCE AMENDED HEREIN) A method of manufacturing a gas discharge panel having a pair of substrates sealed together with a sealant and defining a discharge space